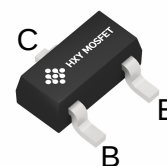


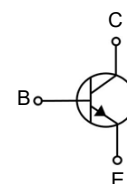


Features

- Collector Current: $I_C=50\text{mA}$
- Power Dissipation of 225mw



SOT-23



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
MMBTH10	SOT-23	3EM	3000

Maxmim Ratings (Ta=25 unless otherwise noted)

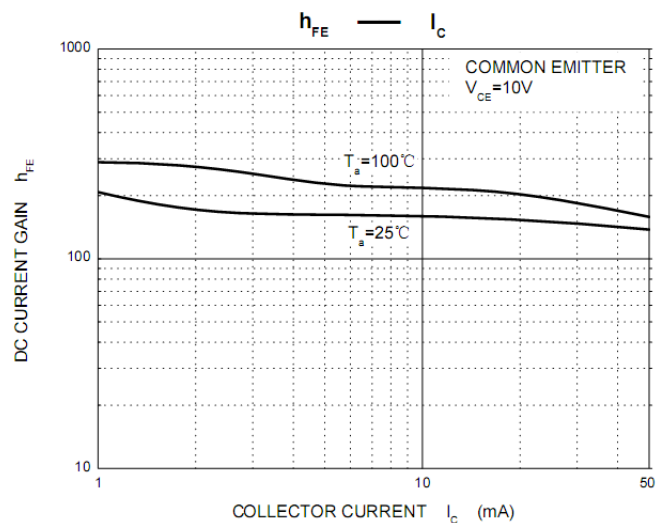
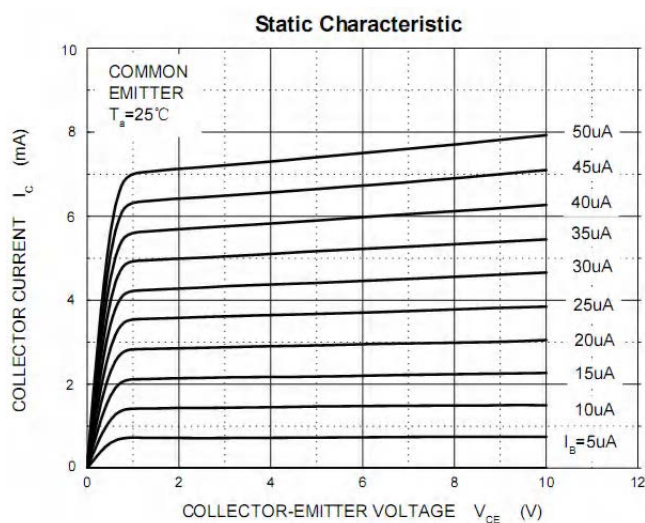
Parameter	Symbol	Limit	Unit
Collector-Base Voltage	V_{CBO}	30	V
Collector-Emitter Voltage	V_{CEO}	25	V
Emitter-Base Voltage	V_{EBO}	3	V
Collector Current	I_C	50	mA
Collector Power Dissipation	P_C	225	mW
Thermal Resistance From Junction To Ambient	$R_{\theta JA}$	556	°C/W
Junction Temperature	T_j	150	°C
Storage Temperature	T_{stg}	-55~+150	°C

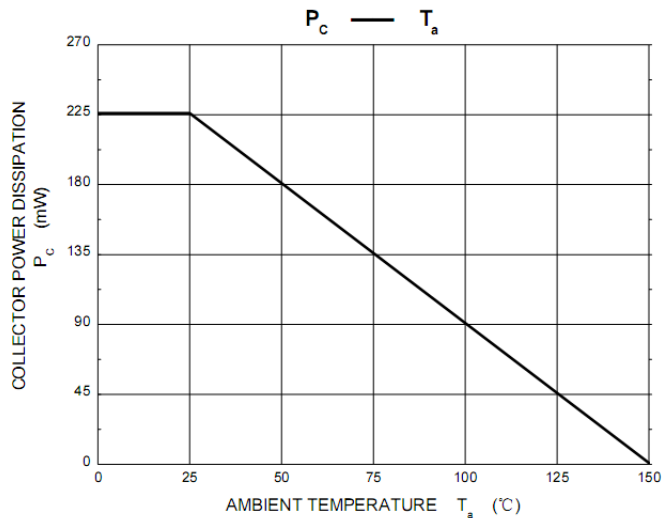
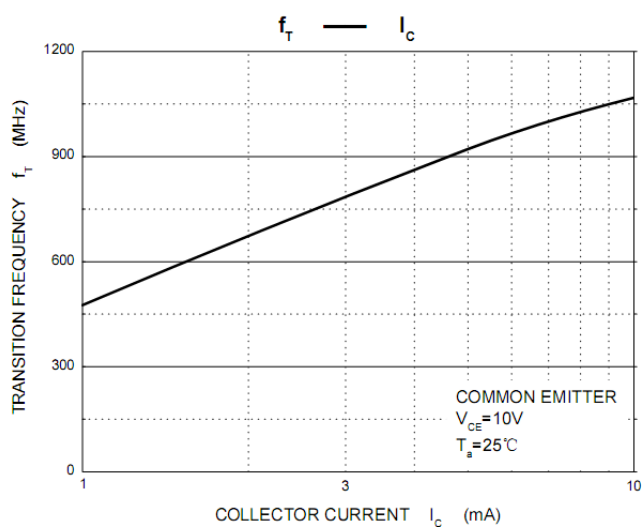
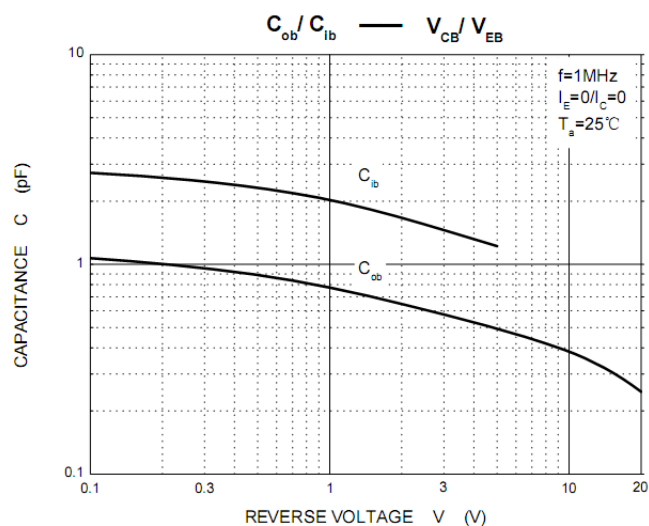
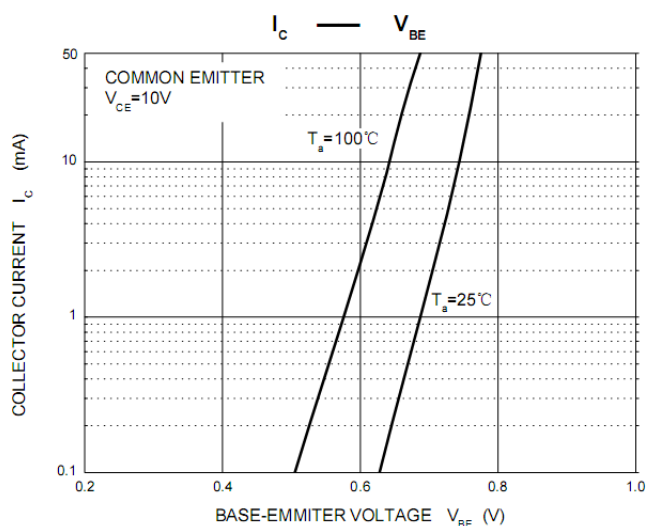
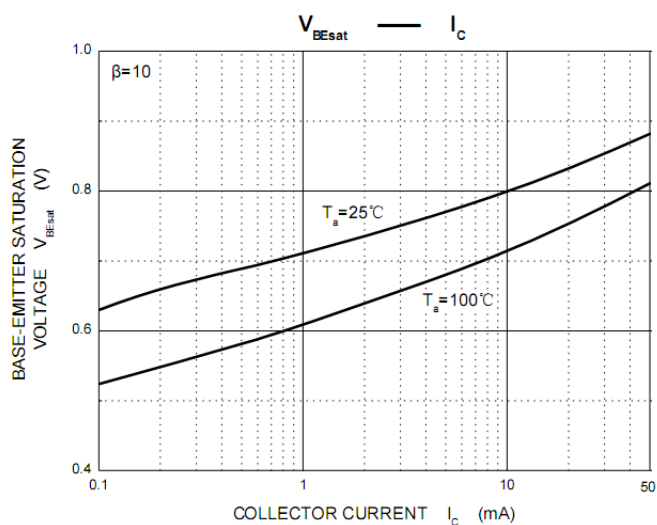
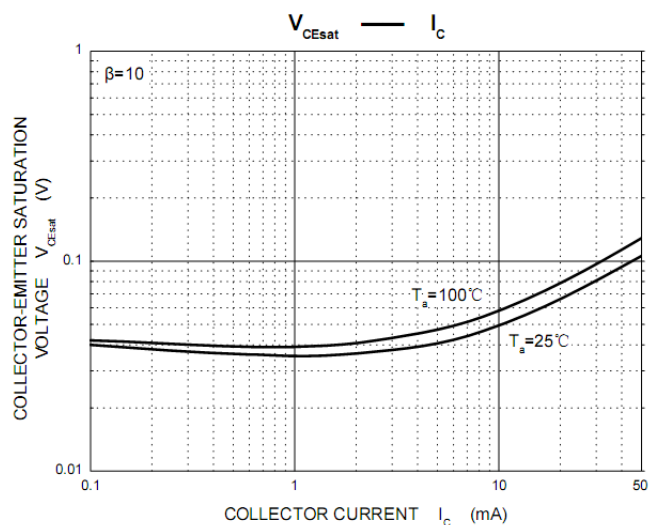


Electrcal Charcteristics (T_a=25 unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Collector-base breakdown voltage	V _{(BR)CBO}	I _C =100μA, I _E =0	30			V
Collector-emitter breakdown voltage	V _{(BR)CEO}	I _C =1mA, I _B =0	25			V
Emitter-base breakdown voltage	V _{(BR)EBO}	I _E =10μA, I _C =0	3			V
Collector cut-off current	I _{CBO}	V _{CB} =25V, I _E =0			0.1	μA
Emitter cut-off current	I _{EBO}	V _{EB} =2V, I _C =0			0.1	μA
DC current gain	h _{FE}	V _{CE} =10V, I _C =4mA	100		200	
Collector-emitter saturation voltage	V _{CE(sat)}	I _C =4mA, I _B =0.4mA			0.5	V
Base-emitter voltage	V _{BE}	V _{CE} =10V, I _C =4mA			0.95	V
Transition frequency	f _T	V _{CE} =10V, I _C =4mA f=100MHz	650			MHz
Collector output capacitance	C _{ob}	V _{CB} =10V, I _E =0, f=1MHz			0.7	pF

Typical Characteristics







SOT-23 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

SOT-23 Suggested Pad Layout



Note:
1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$.
3. The pad layout is for reference purposes only.



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